

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUSHENG LIU	06/23/2017
JAMIN JIANBIN KANG	06/23/2017
XINLEI XU	06/23/2017
RUIYONG JIA	06/23/2017
JIAN GAO	06/23/2017
LIFENG YANG	06/23/2017
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15630883
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	amanda.bernier@emc.com
Correspondent Name:	EMC IP HOLDING COMPANY LLC
Address Line 1:	176 SOUTH STREET
Address Line 4:	HOPKINTON, MASSACHUSETTS 01748
ATTORNEY DOCKET NUMBER:	EMC-16-0554(CN1)US
NAME OF SUBMITTER:	AMANDA M. BERNIER
SIGNATURE:	/Amanda M. Bernier/
DATE SIGNED:	06/23/2017
Total Attachments: 8	
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ASSIGNMENT

WHEREAS, we, Yousheng Liu, Jamin Jianbin Kang, Xinlei Xu, Ruiyong Jia, Jian Gao and Lifeng Yang, have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled *METHOD AND SYSTEM FOR LOCKING STORAGE AREA IN STORAGE SYSTEM* (Application), the specification of which:

- is being executed on even date herewith and is about to be filed in the United States Patent Office;
- was filed on June 22, 2017 as U.S. Application No. 15/630,883;
- was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC IP HOLDING COMPANY LLC (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the State of Delaware and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution,

reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND, we hereby authorize our attorneys, EMC IP HOLDING COMPANY LLC, to insert here in parenthesis (15/630,883 filed June 22, 2017) the application number and filing date of said Application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: 6/23/2017

Yousheng Liu
Inventor's Signature

Print full name of inventor

Yousheng Liu

Residence

Qiangyuang Road, Daxing District
102600 Beijing, CN

Citizenship

CN

Mailing Address

Same as above

I, Baote Zhuo (name of first witness), whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC
was personally present and did see Yousheng Liu (name of person signing the assignment), who
is personally known to me, execute the above assignment.

Baote Zhuo (Signature of first witness)
Signed at 7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC (location of witness signature)
on this day, 06/23, 20 17 (date of signature).

I, Hongpo Gao (name of second witness), whose residential address is
7F block D, Tsinghua Science Park, NO.1 Zhongguancun east Rd. Haidian
was personally present and did see Yousheng Liu (name of person signing the assignment), who Beijing
is personally known to me, execute the above assignment.

Hongpo Gao (Signature of second witness)
Signed at 7F block D, TSP, NO.1 Zhongguancun east Rd. Haidian Beijing (location of witness signature)
on this day, 6.23, 20 17 (date of signature).

Date: 2017.6.23 Jamin Kang
Inventor's Signature

Print full name of inventor Jamin Jianbin Kang
Residence #902, Building 13, WenhuiYuan, Haidian
100082 Beijing, CN
Citizenship CN
Mailing Address Same as above

I, Xiongcheng Li (name of first witness), whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC
was personally present and did see Jamin Jianbin Kang (name of person signing the assignment),
who is personally known to me, execute the above assignment.

Xiongcheng Li (Signature of first witness)
Signed at 7/F, Block D, Tsinghua Science Park, Haidian, Beijing, PRC (location of witness signature)
on this day, 6/23, 2017 (date of signature).

I, Baote Zhuo (name of second witness), whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC
was personally present and did see Jamin Jianbin Kang (name of person signing the assignment),
who is personally known to me, execute the above assignment.

Baote Zhuo (Signature of second witness)
Signed at 7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC (location of witness signature)
on this day, 06/23, 2017 (date of signature).

Date: 2017.6.23 Xinlei Xu
Inventor's Signature

Print full name of inventor Xinlei Xu
Residence 6-6-602, Zhongyuan, Tiantongyuan, Changping
100010 Beijing, CN
Citizenship CN
Mailing Address Same as above

I, Baote Zhuo (name of first witness), whose residential address is
7/F, Block D Tsinghua Science Park, Haidian, Beijing PRC
was personally present and did see Xinlei Xu (name of person signing the assignment), who is
personally known to me, execute the above assignment.

Baote Zhuo (Signature of first witness)
Signed at 7/F, Block D Tsinghua Science Park, Haidian, Beijing PRC (location of witness signature)
on this day, 06/23, 20 17 (date of signature).

I, Hongpo Gao (name of second witness), whose residential address is
7F block D, Tsinghua Science Park 4D, Zhongguancun east Rd, Haidian
was personally present and did see Xinlei Xu (name of person signing the assignment), who is Beijing
personally known to me, execute the above assignment.

Hongpo Gao (Signature of second witness)
Signed at 7F block D, TSD, 4D, Zhongguancun East Rd, Haidian Beijing (location of witness signature)
on this day, 6.23, 20 17 (date of signature).

Date: 2017.8.23

Ruiyong Jia
Inventor's Signature

Print full name of inventor

Ruiyong Jia

Residence

Room 403, Unit 1, Building 27, 105 West 3rd Ring
North Road, HaiDian District
100010 Beijing, CN

Citizenship

CN

Mailing Address

Same as above

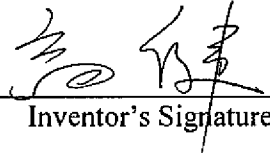
I, Baote Zhuo (name of first witness), whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC
was personally present and did see Ruiyong Jia (name of person signing the assignment), who is
personally known to me, execute the above assignment.

Baote Zhuo (Signature of first witness)
Signed at 7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC (location of witness signature)
on this day, 06/23, 2017 (date of signature).

I, Hongpo Gao (name of second witness), whose residential address is
7F block D, TSD, No. Zhongnancun East Rd, Haidian, Beijing
was personally present and did see Ruiyong Jia (name of person signing the assignment), who is
personally known to me, execute the above assignment.

Hongpo Gao (Signature of second witness)
Signed at 7F Block D, TSD, Zhongnancun East Rd, Haidian, Beijing (location of witness signature)
on this day, 6.23, 2017 (date of signature).

Date: 2017. 6. 23


Inventor's Signature

Print full name of inventor Jian Gao
Residence 601# 16 Building Rongfeng 2008,
Xicheng District
100000 Beijing, CN
Citizenship CN
Mailing Address Same as above

I, Baote Zhuo (name of first witness), whose residential address is 7/F, Block D, Tsinghua Science park, Haidian, Beijing PRC was personally present and did see Jian Gao (name of person signing the assignment), who is personally known to me, execute the above assignment.

Baote Zhuo (Signature of first witness)
Signed at 7/F, Block D, Tsinghua Science park, Haidian Beijing PRC (location of witness signature)
on this day, 06/23, 20 17 (date of signature).

I, Hongpo Gao (name of second witness), whose residential address is 7F block D, TSD, No. Zhongguancun East Rd, Haidian District, was personally present and did see Jian Gao (name of person signing the assignment), who is Beijing personally known to me, execute the above assignment.

Hongpo Gao (Signature of second witness)
Signed at 7F Block D TSD; Zhongguancun East Rd, Haidian, Beijing (location of witness signature)
on this day, 6.23, 20 17 (date of signature).

Date: 2017, 6. 23

Lifeng Yang
Inventor's Signature

Print full name of inventor Lifeng Yang
Residence 10-3-50A, Xingfu-jiayuan, Dongchen District
100062 Beijing, CN
Citizenship CN
Mailing Address Same as above

I, Baote Zhuo (name of first witness), whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC
was personally present and did see Lifeng Yang (name of person signing the assignment), who is
personally known to me, execute the above assignment.

Baote Zhuo (Signature of first witness)
Signed at 7/F, Block D, Tsinghua Science Park, Haidian, Beijing PRC (location of witness signature)
on this day, 06/23, 2017 (date of signature).

I, Hongpo Gao (name of second witness), whose residential address is
7F Block D, Tsinghua No 1 Zhongguancun east Rd, Haidian Beijing
was personally present and did see Lifeng Yang (name of person signing the assignment), who
is personally known to me, execute the above assignment.

Hongpo Gao (Signature of second witness)
Signed at 7F Block D, Tsinghua No 1, Zhongguancun east Rd, Haidian Beijing (location of witness signature)
on this day, 6.23, 2017 (date of signature).